

# HCPL2631 DUAL-CHANNEL OPTOCOUPLER/OPTOISOLATOR

SOOS017 D3114, APRIL 1988

- Gallium Arsenide Phosphide LED Optically Coupled to an Integrated Circuit Detector
- Compatible with TTL and LSTTL Inputs
- Low Input Current Required for On-State Output . . . 5 mA Max
- High-Voltage Electrical Insulation . . . 3000 V DC Min
- High-Speed Switching . . . 75 ns Max
- Directly Interchangeable with Hewlett Packard HCPL2631
- UL Recognized . . . File Number E65085
- Internal Shield for High Common-Mode Rejection

## description

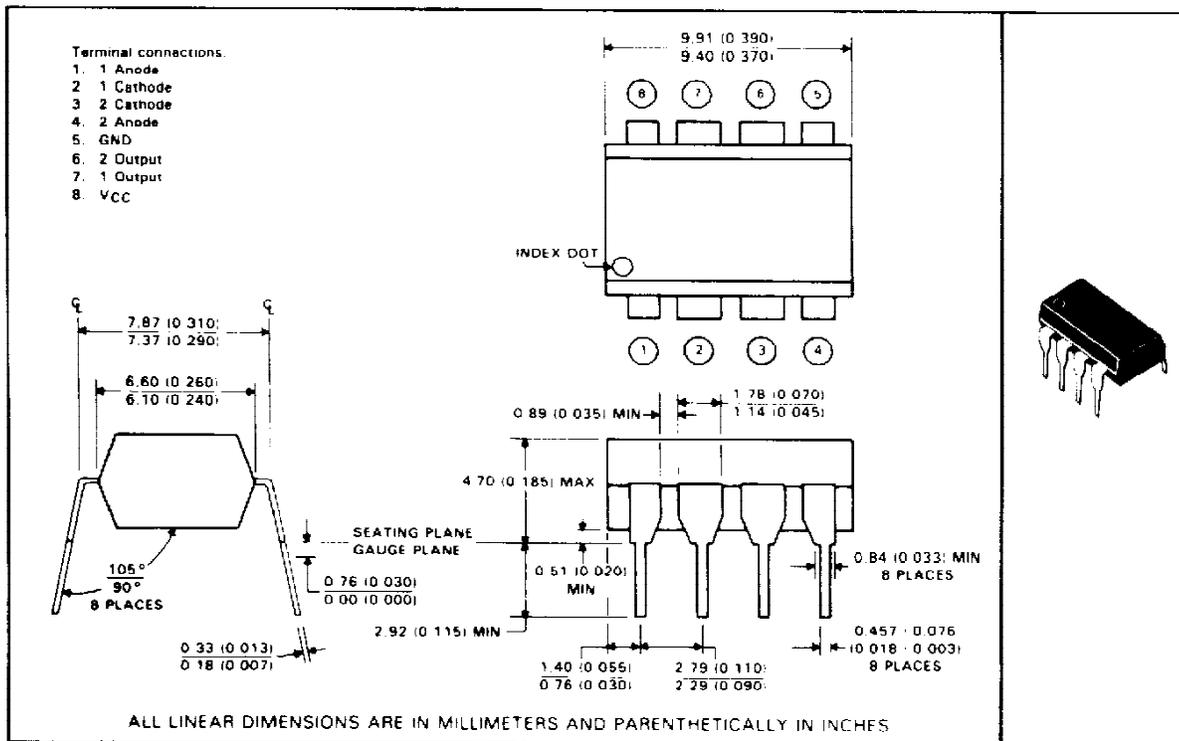
The HCPL2631 is a dual optocoupler designed for use in high-speed digital interfacing applications that require high-voltage isolation between the input and output. Applications include line receivers, microprocessors or computer interface, and other control systems.

Each channel of the HCPL2631 optocoupler consists of a GaAsP light-emitting diode and an integrated light detector composed of a photodiode, a high-gain amplifier, and a Schottky-clamped open-collector output transistor. An input diode forward current of 5 mA will switch the output transistor low, providing an on-state drive current of 13 mA (eight 1.6-mA TTL loads).

The device is mounted in a standard 8-pin dual-in-line plastic package. The internal shield provides a guaranteed common-mode transient immunity of 1000 V/μs minimum.

The HCPL2631 is characterized for operation over the temperature range of 0°C to 70°C.

## mechanical data



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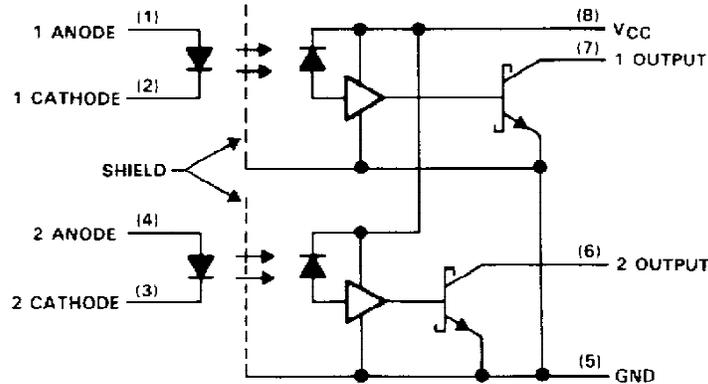


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**HCPL2631  
DUAL-CHANNEL OPTOCOUPLER/OPTOISOLATOR**

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC	7 V
Reverse input voltage	5 V
Output voltage	7 V
Peak forward input current, each channel ( $\leq 1$ ms duration)	30 mA
Average forward input current, each channel	15 mA
Output current, each channel	16 mA
Output power dissipation	85 mW
Storage temperature range	-55°C to 125°C
Operating free-air temperature range	0°C to 70°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

recommended operating conditions

	MIN	NOM	MAX	UNIT	
VCC	Output supply voltage (see Note 1)	4.5	5	5.5	V
I <sub>F(on)</sub>	Input forward current to turn output on	6.3	15		mA
I <sub>F(off)</sub>	Input forward current to turn output off	0	250		μA
I <sub>OL</sub>	Low-level (on-state) output current		13		mA
T <sub>A</sub>	Operating free-air temperature	0	70		°C

NOTE 1: All voltage values are with respect to GND (pin 5).

## HCPL2631 DUAL-CHANNEL OPTOCOUPLER/OPTOISOLATOR

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT
V <sub>F</sub>	Input forward voltage		1.6	1.75	V
α <sub>VF</sub>	Temperature coefficient of forward voltage		-1.8		mV/°C
V <sub>BR</sub>	Input reverse breakdown voltage	I <sub>R</sub> = 10 μA, T <sub>A</sub> = 25°C	5		V
V <sub>OL</sub>	Low-level output voltage	V <sub>CC</sub> = 5.5 V, I <sub>F</sub> = 5 mA, I <sub>OL</sub> = 13 mA	0.23	0.6	V
I <sub>OH</sub>	High-level output current	V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V, I <sub>F</sub> = 250 μA		250	μA
I <sub>CCH</sub>	Supply current, high-level output	V <sub>CC</sub> = 5.5 V, I <sub>F</sub> = 0	20	30	mA
I <sub>CCL</sub>	Supply current, low-level output	V <sub>CC</sub> = 5.5 V, I <sub>F</sub> = 10 mA	26	38	mA
I <sub>II</sub>	Input-input insulation leakage current	V <sub>II</sub> = 500 V, t = 5 s, T <sub>A</sub> = 25°C, RH = 45%, See Note 2	0.005		μA
I <sub>IO</sub>	Input-output insulation leakage current	V <sub>IO</sub> = 3000 V, t = 5 s, T <sub>A</sub> = 25°C, RH = 45%, See Note 1		1	μA
r <sub>II</sub>	Input-input resistance	V <sub>II</sub> = 500 V, T <sub>A</sub> = 25°C, See Note 2	10 <sup>11</sup>		Ω
r <sub>IO</sub>	Input-output resistance	V <sub>IO</sub> = 500 V, T <sub>A</sub> = 25°C, See Note 1	10 <sup>12</sup>		Ω
C <sub>I</sub>	Input capacitance	V <sub>F</sub> = 0, f = 1 MHz	60		pF
C <sub>II</sub>	Input-input capacitance	V <sub>F</sub> = 0, f = 1 MHz	0.25		pF
C <sub>IO</sub>	Input-output capacitance	f = 1 MHz, T <sub>A</sub> = 25°C, See Note 1	0.6		pF

<sup>†</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

NOTES: 1. These parameters are measured between pins 1, 2, 3, and 4 shorted together and pins 5, 6, 7, and 8 shorted together.  
2. These parameters are measured between pins 1 and 2 shorted together and pins 3 and 4 shorted together.

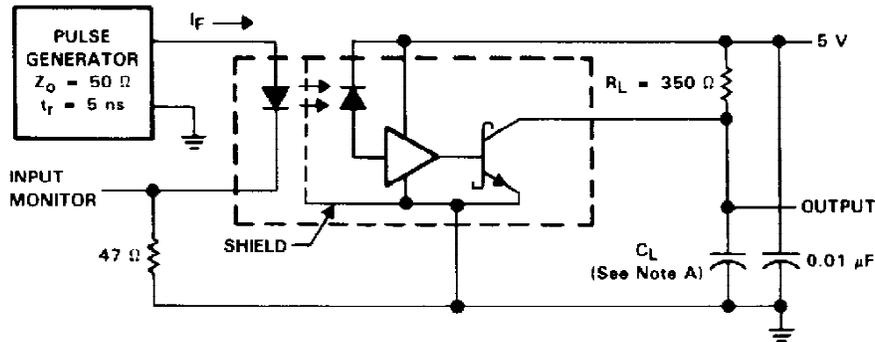
switching characteristics at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t <sub>PLH</sub>	Propagation delay time, low-to-high-level output, from LED input	I <sub>F</sub> = 7.5 mA, R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF, See Figure 1	42	75	ns
t <sub>PHL</sub>	Propagation delay time, high-to-low level output, from LED input	I <sub>F</sub> = 7.5 mA, R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF, See Figure 1	42	75	ns
t <sub>r</sub>	Rise time	I <sub>F</sub> = 7.5 mA, R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF	20		ns
t <sub>f</sub>	Fall time	I <sub>F</sub> = 7.5 mA, R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF	30		ns
$\frac{dV_{LM}}{dt}$ (H)	Common-mode input transient immunity, high-level output	ΔV <sub>CM</sub> = 50 V, I <sub>F</sub> = 0, R <sub>L</sub> = 350 Ω, See Note 3 and Figure 2	1000	10 000	V/μs
$\frac{dV_{CM}}{dt}$ (L)	Common-mode input transient immunity, low-level output	ΔV <sub>CM</sub> = -50 V, I <sub>F</sub> = 5 mA, R <sub>L</sub> = 350 Ω, See Note 3 and Figure 2	-1000	-10 000	V/μs

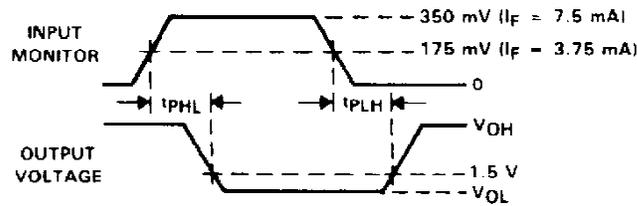
NOTE 3: Common-mode input transient immunity, high-level output, is the maximum rate of rise of the common-mode input voltage that does not cause the output voltage to drop below 2 V. Common-mode input transient immunity, low-level output, is the maximum rate of fall of the common-mode input voltage that does not cause the output voltage to rise above 0.8 V.

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**PARAMETER MEASUREMENT INFORMATION  
(EACH CHANNEL)**



TEST CIRCUIT



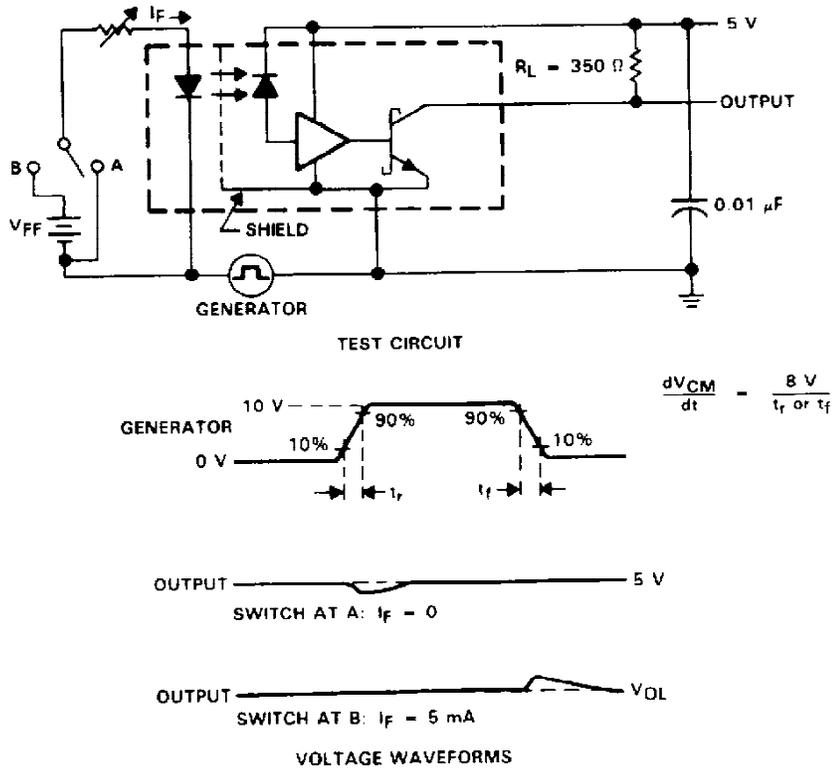
WAVEFORMS

NOTE A:  $C_L$  is approximately  $15 \text{ pF}$ , which includes probe and stray wiring capacitances

**FIGURE 1.  $t_{PLH}$  AND  $t_{PHL}$  FROM LED INPUT TEST CIRCUIT AND WAVEFORMS**

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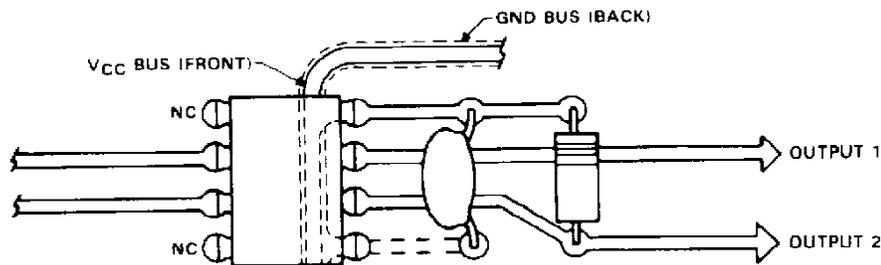
**PARAMETER MEASUREMENT INFORMATION**  
**(EACH CHANNEL)**



**FIGURE 2. TRANSIENT IMMUNITY TEST CIRCUIT AND WAVEFORMS**

**TYPICAL APPLICATION INFORMATION**

A ceramic capacitor (0.01  $\mu\text{F}$  to 0.1  $\mu\text{F}$ ) should be connected between pins 8 and 5 to stabilize the high-gain amplifier. The total lead length between the capacitor and the optocoupler should not exceed 20 mm (0.8 inches). Failure to provide a bypass capacitor may result in impaired switching characteristics.



**FIGURE 3. RECOMMENDED PRINTED CIRCUIT BOARD LAYOUT**

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**TYPICAL CHARACTERISTICS**

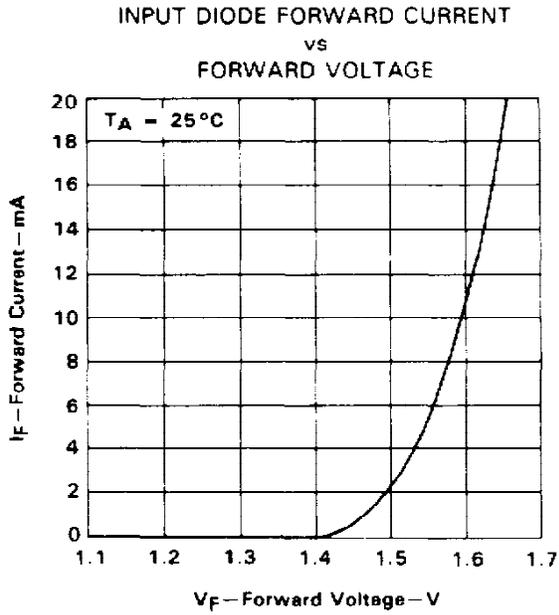


FIGURE 4

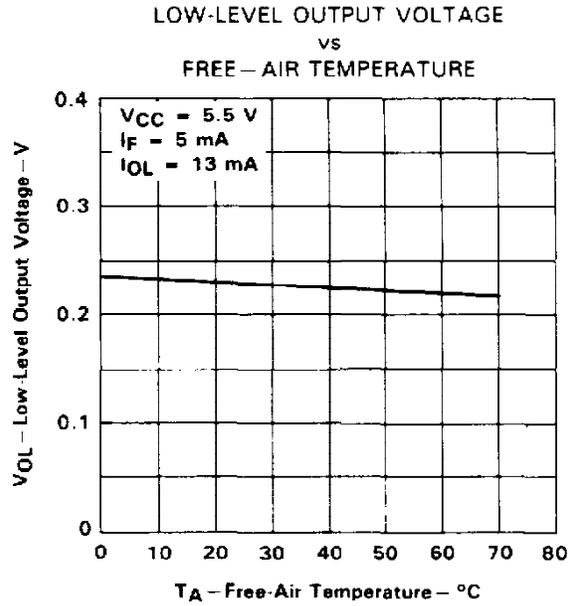


FIGURE 5

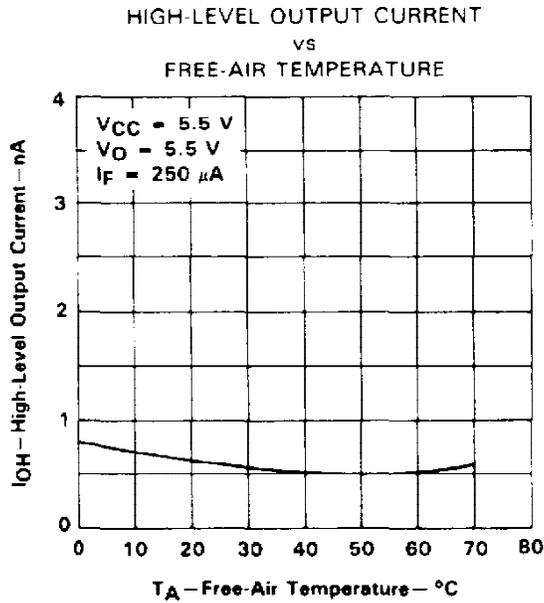


FIGURE 6

**HCPL2631**  
**DUAL-CHANNEL OPTOCOUPLER/OPTOISOLATOR**

**TYPICAL CHARACTERISTICS**

PROPAGATION DELAY TIME FROM LED INPUT  
VS  
PULSE FORWARD CURRENT

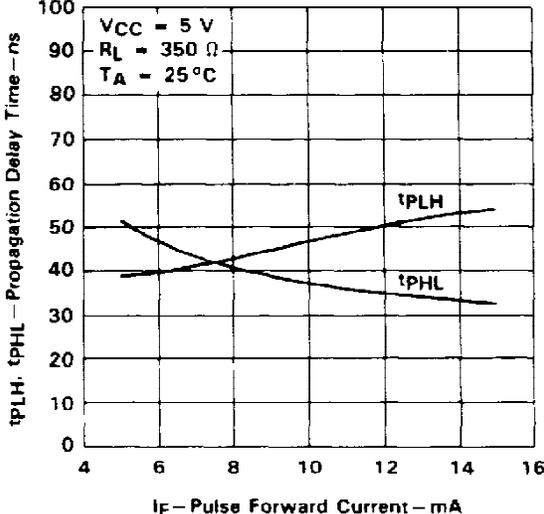


FIGURE 7

PROPAGATION DELAY TIME FROM LED INPUT  
VS  
LOAD RESISTANCE

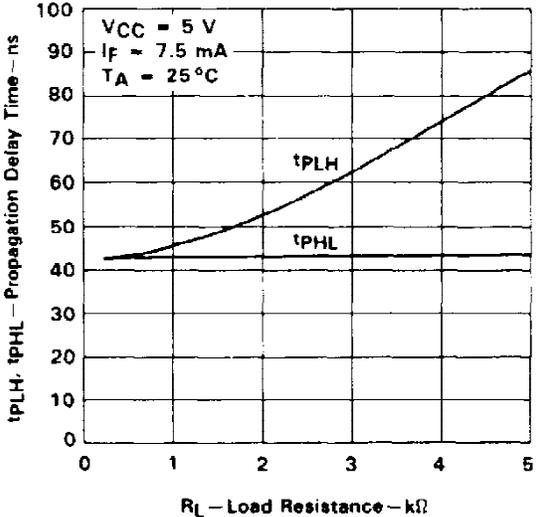


FIGURE 8

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Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
HCPL2631	OBSOLETE	PDIP	N	8		TBD	Call TI	Call TI

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<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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